Attorney Docket No.: AM2119/T2130

AMAT No.: AM2119/T21300

TTC No.: 16301M-021300US

## Amendments to the Claims:

Please cancel claims 25 and 26; and amend claim 22 as indicated in the following list of claims, which replaces all prior versions and listings of claims in the application.

## **Listing of Claims:**

The following listing of claims is provided for the convenience of the Examiner. Claims 22 has been amended. Claims 25 and 26 have been canceled.

1.-15. (Canceled).

16. (Withdrawn) A substrate processing apparatus, comprising:

- a processing chamber having an intake port;
- a supply of nonplasma diluent gas;

a plasma source for generating a plasma consisting of reactive radicals, said plasma source including a conductive plasma applicator defining an internal volume, said applicator having an input aperture and an output aperture, which are equipped with microwave arrestors disposed at said input aperture and at said output aperture to prevent egression of plasma from said internal volume through said input aperture and said output aperture;

a mixing manifold having multiple inlets and an outlet with said outlet being coupled to said intake port and one of said inlets being in fluid communication with said output aperture of said conductive plasma applicator, with the remaining inlets being in fluid communication with said supply of diluent gas;

a pump system, in fluid communication with both said plasma source and said supply of diluent gas, to create a diluent gas flow and a flow of said reactive radicals, with said flow of said reactive radicals traversing said output aperture toward said mixing manifold and said flow of gas traveling from said supply to said mixing manifold, with said diluent gas flow and said flow of said reactive radicals combining when traveling between said inlets and said

Appl. No. 08/893,917 Amdt. dated June 21, 2007 Examining Group 1763

Attorney Docket No.: AM2119/T21300 AMAT No.: AM2119/T21300

TTC No.: 16301M-021300US

outlet forming a gas-radical mixture egressing from said outlet and traversing through said intake port;

a controller configured to regulate said pump system and said plasma source; and a memory, coupled to said controller, comprising a computer-readable medium having a computer-readable program embodied therein for directing operation of said substrate processing system, said computer-readable program including a set of computer instructions to be operated on by said controller to regulate the introduction of said radicals from said plasma into said mixing manifold, said set of computer instructions including:

a first subroutine to be operated on by said controller to regulate said pump system to introduce said reactive radicals into said mixing manifold at a first rate and said diluent gas at a second rate so as to maintain a pressure with said chamber less than one torr.

- 17. (Withdrawn) The apparatus of claim 16 wherein said first rate is in the range of 200 and 400 sccm and said second rate is in the range of 500 and 800 sccm.
- 18. (Withdrawn) The apparatus of claim 16 further including a gas delivery system in fluid communication with said plasma applicator to transmit a reactive gas thereto, with said controller being configured to regulate gas delivery system, wherein said set of computer instructions further includes a second subroutine instructions to be operated on by said controller to regulate said gas delivery system to introduce said reactive gas at a first rate to said gas inlet during a first time period at a first flow rate; a third subroutine of computer instructions for controlling said pump system to maintain a pressure of about 1-20 torr within said applicator during said first time period.
- 19. (Withdrawn) The apparatus of claim 16 further including a microwave source in electrical communication with said plasma applicator, with said controller being configured to regulate said microwave source, wherein said set of computer instructions further includes a fourth subroutine to be operated on by said controller to regulate said microwave

Attorney Docket No.: AM2119/T21300

AMAT No.: AM2119/T21300 TTC No.: 16301M-021300US

source to direct microwaves into said internal volume of said applicator during said first time period.

20. (Withdrawn) The apparatus of claim 19 wherein said fourth subset of computer instructions controls said remote microwave plasma system to direct said microwave energy at a power level ranging from about 150-500 W to ignite said plasma in said applicator.

21. (Canceled).

22. (Currently Amended) A method of removing residue from a substrate processing chamber, said method comprising the steps of:

forming a plasma remotely with respect to said chamber, said plasma including a plurality of reactive radicals;

forming a flow of said reactive radicals traversing toward said chamber;

forming a nonplasma diluent gas flow, wherein said nonplasma diluent gas flow

## comprises at least one of an inert gas or a reduction gas;

mixing said flow of said reactive radicals and said diluent gas flow at a mixing location downstream of a location of forming said flow of said reactive radicals and anterior to said chamber to form a gas-radical mixture; and

flowing said gas-radical mixture into said chamber.

- 23. (Previously presented) The method as recited in claim 22 wherein said flow of reactive radicals and said gas flow are established to maintain a pressure within said chamber below one torr.
- 24. (Previously presented) The method as recited in claim 22 wherein said reactive radicals comprise atoms associated with a reactive gas, with said reactive gas being selected from a group consisting of NF<sub>3</sub>, dilute F<sub>2</sub>, CF<sub>4</sub>, C<sub>2</sub>F<sub>6</sub>, C<sub>3</sub>F<sub>8</sub>, SF<sub>6</sub>, and CIF<sub>3</sub>.

Appl. No. 08/893,917 Amdt. dated June 21, 2007 Examining Group 1763

Attorney Docket No.: AM2119/T21300 AMAT No.: AM2119/T21300 TTC No.: 16301M-021300US

- 25. (Canceled).
- 26. (Canceled).
- 27. (Previously presented) The method as recited in claim 22 wherein said chamber has components therein, with a subset of said radicals in said gas-radical mixture reacting with said components creating a residue and further including the step of exhausting said residue, with a rate at which said residue is exhausted depending upon a rate of said diluent gas flow.
- 28. (Previously presented) The method as recited in claim 22 wherein said diluent gas flow travels at a first rate and said flow of said reactive radicals travel at a second rate with a ratio of said first rate to said second rate being at least 2:1.